

Docket No.: INTEL-0069

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Edward R. HURLEY et al.

Serial No: 10/806,118

Filed: March 23, 2004



Confirmation No.: 2131

Group Art Unit: 1725

Examiner: R. Beveridge

Customer No.: 34610

For: METALLIC SOLDER THERMAL INTERFACE MATERIAL LAYER AND APPLICATION OF THE SAME

U.S. Patent and Trademark Office  
Customer Window, Mail Stop Amendment  
Randolph Building  
401 Dulany Street  
Alexandria, Virginia 22314

Dear Sir:

Transmitted herewith is an Amendment and/or Reply in the above identified application.

- ☒ No additional fee is required.  
☒ Also attached: executed Declaration

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	30	30	0	x \$50.00 =	\$0.00
Independent Claims	3	5	0	x \$200.00=	\$0.00
If multiple claims newly presented, add \$360.00					\$0.00
Fee for extension of time					\$0.00
<b>TOTAL FEE DUE</b>					<b>\$0.00</b>

- ☐ Please charge my Deposit Account No. 16-0607 in the amount of \$\_\_\_\_. An additional copy of this transmittal sheet is submitted herewith.
- ☐ A check in the amount of \$\_\_\_\_\_ (Check #\_\_\_\_) is attached.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 16-0607, including any filing fees under 37 C.F.R. 1.16 for presentation of extra claims and any patent application processing fees under 37 C.F.R. 1.17.

Respectfully submitted,  
FLESHNER & KIM, LLP

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Date: March 30, 2006

**Please direct all correspondence to Customer Number 34610**

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AMENDMENT

U.S. Patent and Trademark Office  
Customer Window, Mail Stop Amendment  
Randolph Building  
401 Dulany Street  
Alexandria, Virginia 22314

Sir:

In reply to the Office Action of January 18, 2006, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims.

**Remarks** begin after the listing of the claims.